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(54) Title: DIELECTRIC FILM-FORMING COMPOSITION

(57) Abstract: This disclosure relates to a dielectric film-forming composition that includes (a) at least one cyanate ester compound, the at least one cyanate ester compound containing at least two cyanate groups; and (b) at least one dielectric polymer including a polybenzoxazole precursor polymer, a polyimide precursor polymer, or a fully imidized polyimide polymer.

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